

Electronic Patent Application Fee Transmittal

Application Number:	10517445			
Filing Date:	09-Dec-2004			
Title of Invention:	Circuit formation substrate manufacturing method and circuit formation substrate material			
First Named Inventor/Applicant Name:	Toshihiro Nishii			
Filer:	Walter Carl Pledger/Linda Deutscher			
Attorney Docket Number:	2004-1930A			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180